	n	Note QT:Qualification Te			_	COUNT	UNLESS OTHERWISE SPECIFIED , REFER	REMARKS NOTE1:INCLUDING THE NOTE2:STORAGEIS DEF APPLY OPERATION TEM	\triangleright	SOLDERABILITY			SOLDERING	DAMP HEAT (STEADY STATE)	TEMPERATURE		SHOCK	VIBRATION		_	VOLTAGE PROOF	INSULATION	CONTACT RESISTANCE 100m A (DC	MARKING	GENERAL EXAMINATION	ITEM		CURRENT	RATING VOLTAGE	
ו בטוו וסילווטא	Test AT:Assurance Test X:Applicable Test SPECIFICATION SHEET			DIS-H-001214	DESCRIPTION OF REVISIONS	PECIFIED, REFER TO JISC 5402.	REMARKS NOTE1:INCLUDING THE TEMPERATURE RISE BY CURRENT. NOTE2:STORAGEIS DEFINED AS LONG-TERM STORAGE OF UNUSED PRODUCTS. APPLY OPERATION TEMPERATURE RANGE TO PRODUCTS MOUNTED ON PCB WITHOUT POWER SUPLLY.		SOLDERING TEMPARATURE:245±5°C DURATION OF IMMERSION : SOLDERING FOR 3SECONDS	SAME CONDITION. [RECOMMENDED MANUAL SOLDELING CONDITION] SOLDERING IRON TEMPERATURE 380°C SOLDERING TIME: WITHIN 3 SECONDS.	MAXIMUM TWICE ACTION IS ALLOWED UNDER THE SAME CONDITION. TRECOMMENDED MANIMUM SOLDELING CONDITION 1	[RECOMMENDED TEMPERATURE PROFIL (SOLDERING AREA) MAX250°C, 220°C FOR 60 SECONDS MAX (PREHEATING AREA)	ി ശ	5 TO 35→125→ 10 TO 15→ 30→	IRONMENT	490 m/s ² DURATION OF PULSE 11 ms AT FOR 3 DIRECTIONS.	FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.	30TIMES INSERTIONS AND EXTRACTIONS.	CHARACTERISTICS	250V AC FOR 1 min.	100V DC.	ACTERISTICS 100m A (DC OR 1000 Hz).	CONFIRMED VISUALLY.	VISUALLY AND BY MEASURING INSTRUMENT.	TEST METHOD	SPECIFIC	0.5A	150V AC	RERANGE TO TO TIZE O (NOTES	
	PART NO	DRAWING NO.	APPROVED CHECKED DESIGNED DRAWN	AR. TAKAHASHI	DESIGNED		NUSED PRODUCTS. NUNTED ON PCB WITHOUT F		A NEW UNIFORM CO COVER MINIMUM BEING IMMERSED		D UNDER THE	· <u>b</u>			CHARACTI	3 TIMES	® ⊖	® ()		NO FLASHOVER OR	500MΩ MIN	50mΩ MAX.				-ICATIONS	CONNECTOR	APPLICABLE	LEMTEXA OXE XANGE	
DF9A-*S-1V(22)	DF9A			TS.	CHECKED		OWER SUPLLY.		NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95% OF THE SURFACE BEING IMMERSED.			NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	 ① CONTACT RESISTANCE: 50m MAX. ② INSULATION RESISTANCE: 500 MM MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 	(1) CONTACT RESISTANCE: 50mΩ MAX. (2) INSULATION RESISTANCE: 500 MΩ MIN. (3) NO DAMAGE, GRACK OR LOOSENESS OF PARTS.		 NO ELECTRICAL DISCONTINUITY OF 1µs. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 	NO ELECTRICAL DISCONTINUITY OF 1µS. NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	RESISTANCE: 50 3E, CRACK OR LOO		ER OR BREAKDOWN.	VIIN.	AX.		ACCORDING TO DRAWING.	REQUIREMENTS		DF9#-*P-1V(32)	DF9#-*P-1V(22)	-10.0.10.+	
		-04	05. 10. 31 05. 10. 31	05. 10. 31	06. 08. 02 05. 10. 31	DATE				×		×		×	×	1	×	×	×	×	;	× ;	×	× :		QT AT		32)	22)	60°C (NOTE2)

HIROSE ELECTRIC CO., LTD.

CODE NO.